

## In-System Programmable High Density PLD

## Features

- HIGH DENSITY PROGRAMMABLE LOGIC
- 8,000 PLD Gates
- 96 I/O Pins, Twelve Dedicated Inputs
- 288 Registers
- High-Speed Global Interconnects
- Wide Input Gating for Fast Counters, State Machines, Address Decoders, etc.
- Small Logic Block Size for Random Logic
- Functionally and Pin-out Compatible to ispLSI 1048C
- HIGH PERFORMANCE E²CMOS ${ }^{\circledR}$ TECHNOLOGY
- fmax $=125 \mathrm{MHz}$ Maximum Operating Frequency
- tpd=7.5 ns Propagation Delay
- TTL Compatible Inputs and Outputs
- Electrically Eraseable and Reprogrammable
- Non-Volatile
- 100\% Tested at Time of Manufacture
- IN-SYSTEM PROGRAMMABLE
- In-System Programmable (ISP ${ }^{\text {TM }}$ ) 5V Only
- Increased Manufacturing Yields, Reduced Time-toMarket and Improved Product Quality
- Reprogram Soldered Devices for Faster Prototyping
- OFFERS THE EASE OF USE AND FAST SYSTEM SPEED OF PLDs WITH THE DENSITY AND FLEXIBILITY OF FIELD PROGRAMMABLE GATE ARRAYS
- Complete Programmable Device Can Combine Glue Logic and Structured Designs
- Enhanced Pin Locking Capability
- Four Dedicated Clock Input Pins
- Synchronous and Asynchronous Clocks
- Programmable Output Slew Rate Control to Minimize Switching Noise
- Flexible Pin Placement
- Optimized Global Routing Pool Provides Global Interconnectivity
- Lead-Free Package Options

Functional Block Diagram


0139G1A-isp

## Description

The ispLSI 1048E is a High Density Programmable Logic Device containing 288 Registers, 96 Universal I/O pins, 12 Dedicated Input pins, four Dedicated Clock Input pins, two dedicated Global OE input pins, and a Global Routing Pool (GRP). The GRP provides complete interconnectivity between all of these elements. The ispLSI 1048E offers 5 V non-volatile in-system programmability of the logic, as well as the interconnect to provide truly reconfigurable systems. A functional superset of the ispLSI 1048 architecture, the ispLSI 1048E device adds two new global output enable pins and two additional dedicated inputs.
The basic unit of logic on the ispLSI 1048E device is the Generic Logic Block (GLB). The GLBs are labeled A0, A1...F7 (see Figure 1). There are a total of 48 GLBs in the ispLSI 1048E device. Each GLB has 18 inputs, a programmable AND/OR/Exclusive OR array, and four outputs which can be configured to be either combinatorial or registered. Inputs to the GLB come from the GRP and dedicated inputs. All of the GLB outputs are brought back into the GRP so that they can be connected to the inputs of any other GLB on the device.

## Functional Block Diagram

Figure 1. ispLSI 1048E Functional Block Diagram


The device also has 96 I/O cells, each of which is directly connected to an I/O pin. Each I/O cell can be individually programmed to be a combinatorial input, registered input, latched input, output or bi-directional I/O pin with 3 -state control. The signal levels are TTL compatible voltages and the output drivers can source 4 mA or sink 8 mA . Each output can be programmed independently for fast or slow output slew rate to minimize overall output switching noise.

Eight GLBs, 16 I/O cells, two dedicated inputs and one ORP are connected together to make a Megablock (see figure 1). The outputs of the eight GLBs are connected to a set of 16 universal I/O cells by the ORP. Each ispLSI 1048E device contains six Megablocks.

The GRP has, as its inputs, the outputs from all of the GLBs and all of the inputs from the bi-directional I/O cells. All of these signals are made available to the inputs of the GLBs. Delays through the GRP have been equalized to minimize timing skew.

Clocks in the ispLSI 1048E device are selected using the Clock Distribution Network. Four dedicated clock pins (Y0, Y1, Y2 and Y3) are brought into the distribution network, and five clock outputs (CLK 0, CLK 1, CLK 2, IOCLK 0 and IOCLK 1) are provided to route clocks to the GLBs and I/O cells. The Clock Distribution Network can also be driven from a special clock GLB (D0). The logic of this GLB allows the user to create an internal clock from a combination of internal signals within the device.

Specifications ispLSI 1048E

## Absolute Maximum Ratings 1

Supply Voltage $\mathrm{V}_{\mathrm{cc}}$. ................................. -0.5 to +7.0V
Input Voltage Applied $\qquad$ -2.5 to $V_{C C}+1.0 \mathrm{~V}$

Off-State Output Voltage Applied ..... -2.5 to $\mathrm{V}_{\mathrm{CC}}+1.0 \mathrm{~V}$
Storage Temperature $\qquad$ -65 to $150^{\circ} \mathrm{C}$

Case Temp. with Power Applied $\qquad$ -55 to $125^{\circ} \mathrm{C}$

Max. Junction Temp. ( $\mathrm{T}_{\mathrm{J}}$ ) with Power Applied ... $150^{\circ} \mathrm{C}$

1. Stresses above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or at any other conditions above those indicated in the operational sections of this specification is not implied (while programming, follow the programming specifications).

DC Recommended Operating Conditions

| SYMBOL | PARAMETER |  | MIN. | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| VCC | Supply Voltage | Commercial $\quad \mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | 4.75 | 5.25 | V |
|  |  | Industrial $\quad \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 4.5 | 5.5 | V |
| VIL | Input Low Voltage |  | 0 | 0.8 | V |
| VIH | Input High Voltage |  | 2.0 | $\mathrm{V}_{\mathrm{CC}}+1$ | V |

## Capacitance $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}\right)$

| SYMBOL | PARAMETER | TYPICAL | UNITS | TEST CONDITIONS |
| :--- | :--- | :---: | :---: | :---: |
| $\mathbf{C}_{1}$ | Dedicated Input, I/O, Y1, Y2, Y3, Clock Capacitance | 8 | pf | $\mathrm{V}_{\text {CC }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {PIN }}=2.0 \mathrm{~V}$ |
| $\mathbf{C}_{2}$ | Y0 Clock Capacitance | 15 | pf | $\mathrm{V}_{\text {CC }}=5.0 \mathrm{~V}, \mathrm{~V}_{\text {PIN }}=2.0 \mathrm{~V}$ |

## Data Retention Specifications

| PARAMETER | MINIMUM | MAXIMUM | UNITS |
| :--- | :---: | :---: | :---: |
| Data Retention | 20 | - | Years |
| Erase/Reprogram Cycles | 10000 | - | Cycles |

## Switching Test Conditions

| Input Pulse Levels | GND to 3.0V |
| :--- | :---: |
| Input Rise and Fall Time | $\leq 3 \mathrm{~ns} 10 \%$ to $90 \%$ |
| Input Timing Reference Levels | 1.5 V |
| Output Timing Reference Levels | 1.5 V |
| Output Load | See Figure 2 |

3-state levels are measured 0.5 V from
Figure 2. Test Load

${ }^{*} C_{L}$ includes Test Fixture and Probe Capacitance.
${ }^{0213}$

## DC Electrical Characteristics

Over Recommended Operating Conditions

| SYMBOL | PARAMETER | CONDITION |  | MIN. | TYP ${ }^{3}$ | MAX. | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VOL | Output Low Voltage | $\mathrm{I}_{\mathrm{OL}}=8 \mathrm{~mA}$ |  | - | - | 0.4 | V |
| VOH | Output High Voltage | $\mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA}$ |  | 2.4 | - | - | V |
| IIL | Input or I/O Low Leakage Current | $\mathrm{OV} \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}$ (Max.) |  | - | - | -10 | $\mu \mathrm{A}$ |
| IIH | Input or I/O High Leakage Current | $3.5 \mathrm{~V} \leq \mathrm{V}_{\text {IN }} \leq \mathrm{V}_{\mathrm{CC}}$ |  | - | - | 10 | $\mu \mathrm{A}$ |
| IIL-isp | ispEN Input Low Leakage Current | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}$ |  | - | - | -150 | $\mu \mathrm{A}$ |
| IIL-PU | I/O Active Pull-Up Current | $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{IL}}$ |  | - | - | -150 | $\mu \mathrm{A}$ |
| $\mathrm{IOS}^{1}$ | Output Short Circuit Current | $\mathrm{V}_{\text {CC }}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=0.5 \mathrm{~V}$ |  | - | - | -200 | mA |
| $\mathrm{ICC}^{2,4}$ | Operating Power Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{IL}}=0.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{H}}=3.0 \mathrm{~V} \\ & \mathrm{f}_{\mathrm{CLOCK}}=1 \mathrm{MHz} \end{aligned}$ | Commercial | - | 175 | - | mA |
|  |  |  | Industrial | - | 175 | - | mA |

1. One output at a time for a maximum duration of one second. $\mathrm{V}_{\mathrm{OUT}}=0.5 \mathrm{~V}$ was selected to avoid test problems Table 2-0007/1048E by tester ground degradation. Characterized but not $100 \%$ tested.
2. Measured using twelve 16 -bit counters.
3. Typical values are at $\mathrm{V}_{C C}=5 \mathrm{~V}$ and $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$.
4. Maximum $I_{C C}$ varies widely with specific device configuration and operating frequency. Refer to the Power Consumption section of this data sheet and Thermal Management section of the Lattice Semiconductor Data Book or CD-ROM to estimate maximum $\mathrm{I}_{\mathrm{CC}}$.

External Timing Parameters
Over Recommended Operating Conditions

| PARAMETER | $\begin{aligned} & \text { TEST }{ }^{4} \\ & \text { COND. } \end{aligned}$ | $\#^{2}$ | DESCRIPTION ${ }^{1}$ | -125 |  | -100 |  | -90 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. |  |
| tpd1 | A | 1 | Data Propagation Delay, 4PT Bypass, ORP Bypass | - | 7.5 | - | 10.0 | - | 10.0 | ns |
| tpd2 | A | 2 | Data Propagation Delay, Worst Case Path | - | 10.0 | - | 12.5 | - | 12.5 | ns |
| fmax (Int.) | A | 3 | Clock Frequency with Internal Feedback ${ }^{3}$ | 125.0 | - | 100.0 | - | 90.9 | - | MHz |
| fmax (Ext.) | - | 4 | Clock Frequency with External Feedback ( $\left.\frac{1}{\text { tsu2 }+ \text { tool }} 1\right)$ | 91.0 | - | 71.0 | - | 71.0 | - | MHz |
| fmax (Tog.) | - | 5 | Clock Frequency, Max. Toggle ( $\frac{1}{\mathrm{twh}+\mathrm{twl}}$ ) | 167.0 | - | 125.0 |  | 125.0 | - | MHz |
| tsu1 | - | 6 | GLB Reg. Setup Time before Clock,4 PT Bypass | 5.5 | - | 6.5 |  | 6.5 | - | ns |
| tcol | A | 7 | GLB Reg. Clock to Output Delay, ORP Bypass | - | 4.5 |  | 6.5 | - | 6.5 | ns |
| th1 | - | 8 | GLB Reg. Hold Time after Clock, 4 PT Bypass | 0.0 |  | 0.0 | - | 0.0 | - | ns |
| tsu2 | - | 9 | GLB Reg. Setup Time before Clock | 6.5 |  | 7.5 | - | 7.5 | - | ns |
| tco2 | - | 10 | GLB Reg. Clock to Output Delay |  | 5.5 | - | 7.5 | - | 7.5 | ns |
| th2 | - | 11 | GLB Reg. Hold Time after Clock | 0.0 | - | 0.0 | - | 0.0 | - | ns |
| tr1 | A | 12 | Ext. Reset Pin to Output Delay | - | 10.0 | - | 13.5 | - | 13.5 | ns |
| trw1 | - | 13 | Ext. Reset Pulse Duration | 5.0 | - | 6.5 | - | 6.5 | - | ns |
| tptoeen | B | 14 | Input to Output Enable | - | 12.0 | - | 15.0 | - | 15.0 | ns |
| tptoedis | C | 15 | Input to Output Disable | - | 12.0 | - | 15.0 | - | 15.0 | ns |
| tgoeen | B | 16 | Global OE Output Enable | - | 7.0 | - | 9.0 | - | 9.0 | ns |
| tgoedis | C | 17 | Global OE Output Disable | - | 7.0 | - | 9.0 | - | 9.0 | ns |
| twh | - | 18 | External Synchronous Clock Pulse Duration, High | 3.0 | - | 4.0 | - | 4.0 | - | ns |
| twl | - | 19 | External Synchronous Clock Pulse Duration, Low | 3.0 | - | 4.0 | - | 4.0 | - | ns |
| tsu3 | - | 20 | I/O Reg. Setup Time before Ext. Sync Clock (Y2, Y3) | 3.0 | - | 3.5 | - | 4.0 | - | ns |
| th3 | - | 21 | I/O Reg. Hold Time after Ext. Sync. Clock (Y2, Y3) | 0.0 | - | 0.0 | - | 0.0 | - | ns |

1. Unless noted otherwise, all parameters use a GRP load of 4 GLBs, 20 PTXOR path, ORP and Y0 clock.
2. Refer to Timing Model in this data sheet for further details.
3. Standard 16 -bit counter using GRP feedback.
4. Reference Switching Test Conditions section.

External Timing Parameters
Over Recommended Operating Conditions

| PARAMETER | $\begin{aligned} & \text { TEST }{ }^{4} \\ & \text { COND. } \end{aligned}$ | $\#^{2}$ | DESCRIPTION ${ }^{1}$ | -70 |  | -50 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN. | MAX. | MIN. | MAX. |  |
| tpd1 | A | 1 | Data Propagation Delay, 4PT Bypass, ORP Bypass | - | 15.0 | - | 20.0 | ns |
| tpd2 | A | 2 | Data Propagation Delay, Worst Case Path | - | 18.5 | - | 24.5 | ns |
| fmax (Int.) | A | 3 | Clock Frequency with Internal Feedback ${ }^{3}$ | 70.0 | - | 50.0 | - | MHz |
| fmax (Ext.) | - | 4 | Clock Frequency with External Feedback ( $\left.\frac{1}{\text { tsu2 }+ \text { too1 }} 1\right)$ | 56.0 | - | 42.0 | - | MHz |
| fmax (Tog.) | - | 5 | Clock Frequency, Max. Toggle ( $\frac{1}{\text { twh }+ \text { twl }}$ ) | 100.0 | - | 77.0 | - | MHz |
| tsu1 | - | 6 | GLB Reg. Setup Time before Clock, 4 PT Bypass | 9.0 |  | 12.0 | - | ns |
| tco1 | A | 7 | GLB Reg. Clock to Output Delay, ORP Bypass | - | 7.0 | - | 9.5 | ns |
| th1 | - | 8 | GLB Reg. Hold Time after Clock, 4 PT Bypass | 0.0 | - | 0.0 | - | ns |
| tsu2 | - | 9 | GLB Reg. Setup Time before Clock | 11.0 | - | 14.5 | - | ns |
| tco2 | - | 10 | GLB Reg. Clock to Output Delay | - | 9.0 | - | 12.0 | ns |
| th2 | - | 11 | GLB Reg. Hold Time after Clock | 0.0 | - | 0.0 | - | ns |
| tr1 | A | 12 | Ext. Reset Pin to Output Delay | - | 15.0 | - | 20.5 | ns |
| trw1 | - | 13 | Ext. Reset Pulse Duration | 10.0 | - | 13.0 | - | ns |
| tptoeen | B | 14 | Input to Output Enable | - | 18.0 | - | 24.0 | ns |
| tptoedis | C | 15 | Input to Output Disable | - | 18.0 | - | 24.0 | ns |
| tgoeen | B | 16 | Global OE Output Enable | - | 12.0 | - | 16.0 | ns |
| tgoedis | C | 17 | Global OE Output Disable | - | 12.0 | - | 16.0 | ns |
| twh | - | 18 | External Synchronous Clock Pulse Duration, High | 5.0 | - | 6.5 | - | ns |
| twl | - | 19 | External Synchronous Clock Pulse Duration, Low | 5.0 | - | 6.5 | - | ns |
| tsu3 | - | 20 | I/O Reg. Setup Time before Ext. Sync Clock (Y2, Y3) | 4.0 | - | 6.5 | - | ns |
| th3 | - | 21 | I/O Reg. Hold Time after Ext. Sync. Clock (Y2, Y3) | 0.0 | - | 0.0 | - | ns |

1. Unless noted otherwise, all parameters use a GRP load of $4 \mathrm{GLBs}, 20$ PTXOR path, ORP and Y0 clock.
2. Refer to Timing Model in this data sheet for further details.
3. Standard 16 -bit counter using GRP feedback.
4. Reference Switching Test Conditions section.

Internal Timing Parameters ${ }^{1}$

| PARAMETER | $\#^{2}$ | DESCRIPTION | -125 |  | -100 |  | -90 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. |  |
| Inputs |  |  |  |  |  |  |  |  |  |
| tiobp | 22 | I/O Register Bypass | - | 0.3 | - | 0.3 | - | 0.5 | ns |
| tiolat | 23 | I/O Latch Delay | - | 1.9 | - | 2.3 | - | 2.5 | ns |
| tiosu | 24 | I/O Register Setup Time before Clock | 3.0 | - | 3.5 | - | 4.0 | - | ns |
| tioh | 25 | I/O Register Hold Time after Clock | 0.0 | - | 0.0 | - | -0.5 | - | ns |
| tioco | 26 | I/O Register Clock to Out Delay | - | 4.6 | - | 5.0 | - | 5.0 | ns |
| tior | 27 | I/O Register Reset to Out Delay | - | 4.6 | - | 5.0 | - | 5.0 | ns |
| tdin | 28 | Dedicated Input Delay | - | 2.3 | - | 2.7 | - | 2.9 | ns |
| GRP |  |  |  |  |  |  |  |  |  |
| tgrp1 | 29 | GRP Delay, 1 GLB Load | - | 1.8 | - | 1.9 | - | 2.2 | ns |
| tgrp4 | 30 | GRP Delay, 4 GLB Loads | - | 2.0 | - | 2.4 | - | 2.4 | ns |
| tgrp8 | 31 | GRP Delay, 8 GLB Loads | - | 2.3 | - | 2.6 | - | 2.7 | ns |
| tgrp16 | 32 | GRP Delay, 16 GLB Loads | - | 2.8 | - | 3.0 | - | 3.3 | ns |
| tgrp48 | 33 | GRP Delay, 48 GLB Loads | - | 4.9 | - | 5.4 | - | 5.7 | ns |
| GLB |  |  |  |  |  |  |  |  |  |
| t4ptbpc | 34 | 4 Product Term Bypass Path Delay (Combinatorial) | - | 3.9 | - | 5.3 | - | 5.4 | ns |
| t4ptbpr | 35 | 4 Product Term Bypass Path Delay (Registered) | - | 4.0 | - | 5.3 | - | 6.3 | ns |
| t1ptxor | 36 | 1 Product Term/XOR Path Delay | - | 3.6 | - | 4.6 | - | 6.5 | ns |
| t20ptxor | 37 | 20 Product Term/XOR Path Delay | - | 5.0 | - | 5.8 | - | 6.5 | ns |
| txoradj | 38 | XOR Adjacent Path Delay ${ }^{3}$ | - | 5.0 | - | 6.3 | - | 7.3 | ns |
| tgbp | 39 | GLB Register Bypass Delay | - | 0.4 | - | 1.0 | - | 0.4 | ns |
| tgsu | 40 | GLB Register Setup Time before Clock | 0.1 | - | 0.5 | - | 0.1 | - | ns |
| tgh | 41 | GLB Register Hold Time after Clock | 4.5 | - | 5.3 | - | 6.4 | - | ns |
| tgco | 42 | GLB Register Clock to Output Delay | - | 2.3 | - | 2.5 | - | 2.0 | ns |
| tgro | 43 | GLB Register Reset to Output Delay | - | 4.9 | - | 6.2 | - | 6.3 | ns |
| tptre | 44 | GLB Product Term Reset to Register Delay | - | 3.9 | - | 4.5 | - | 5.0 | ns |
| tptoe | 45 | GLB Product Term Output Enable to I/O Cell Delay | - | 5.4 | - | 7.2 | - | 5.7 | ns |
| tptck | 46 | GLB Product Term Clock Delay | 2.9 | 4.0 | 3.5 | 4.7 | 4.0 | 5.2 | ns |
| ORP |  |  |  |  |  |  |  |  |  |
| torp | 47 | ORP Delay | - | 1.0 | - | 1.0 | - | 1.0 | ns |
| torpbp | 48 | ORP Bypass Delay | - | 0.0 | - | 0.0 | - | 0.0 | ns |
| 1. Internal Timing Parameters are not tested and are for reference only. <br> 2. Refer to Timing Model in this data sheet for further details. <br> 3. The XOR adjacent path can only be used by hard macros. |  |  |  |  |  |  |  |  |  |

Internal Timing Parameters ${ }^{1}$

| PARAMETER | $\#^{2}$ | DESCRIPTION | -70 |  | -50 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN. | MAX. | MIN. | MAX. |  |
| Inputs |  |  |  |  |  |  |  |
| tiobp | 22 | I/O Register Bypass | - | 0.6 | - | 0.7 | ns |
| tiolat | 23 | I/O Latch Delay | - | 3.6 | - | 4.7 | ns |
| tiosu | 24 | I/O Register Setup Time before Clock | 4.1 | - | 6.5 | - | ns |
| tioh | 25 | I/O Register Hold Time after Clock | -0.6 | - | -0.7 | - | ns |
| tioco | 26 | I/O Register Clock to Out Delay | - | 6.0 | - | 7.0 | ns |
| tior | 27 | I/O Register Reset to Out Delay | - | 6.0 | - | 7.0 | ns |
| tdin | 28 | Dedicated Input Delay | - | 4.3 | - | 6.1 | ns |
| GRP |  |  |  |  |  |  |  |
| tgrp1 | 29 | GRP Delay, 1 GLB Load | - | 3.5 | - | 5.1 | ns |
| tgrp4 | 30 | GRP Delay, 4 GLB Loads | - | 3.7 | - | 5.4 | ns |
| tgrp8 | 31 | GRP Delay, 8 GLB Loads | - | 4.1 | - | 5.8 | ns |
| tgrp16 | 32 | GRP Delay, 16 GLB Loads | - | 4.8 | - | 6.6 | ns |
| tgrp48 | 33 | GRP Delay, 48 GLB Loads | - | 7.5 | - | 9.8 | ns |
| GLB |  |  |  |  |  |  |  |
| t4ptbpc | 34 | 4 Product Term Bypass Path Delay (Combinatorial) | - | 8.5 | - | 10.7 | ns |
| t4ptbpr | 35 | 4 Product Term Bypass Path Delay (Registered) | - | 7.4 | - | 9.2 | ns |
| t1ptxor | 36 | 1 Product Term/XOR Path Delay | - | 8.4 | - | 10.5 | ns |
| t20ptxor | 37 | 20 Product Term/XOR Path Delay | - | 8.4 | - | 10.5 | ns |
| txoradj | 38 | XOR Adjacent Path Delay ${ }^{3}$ | - | 9.4 | - | 11.7 | ns |
| tgbp | 39 | GLB Register Bypass Delay | - | 1.6 | - | 2.2 | ns |
| tgsu | 40 | GLB Register Setup Time before Clock | 0.1 | - | 0.0 | - | ns |
| tgh | 41 | GLB Register Hold Time after Clock | 8.5 | - | 11.5 | - | ns |
| tgco | 42 | GLB Register Clock to Output Delay | - | 2.0 | - | 3.0 | ns |
| tgro | 43 | GLB Register Reset to Output Delay | - | 6.3 | - | 7.3 | ns |
| tptre | 44 | GLB Product Term Reset to Register Delay | - | 6.1 | - | 7.9 | ns |
| tptoe | 45 | GLB Product Term Output Enable to I/O Cell Delay | - | 6.8 | - | 10.0 | ns |
| tptck | 46 | GLB Product Term Clock Delay | 5.1 | 6.4 | 6.9 | 8.3 | ns |
| ORP |  |  |  |  |  |  |  |
| torp | 47 | ORP Delay | - | 2.0 | - | 2.5 | ns |
| torpbp | 48 | ORP Bypass Delay | - | 0.0 | - | 0.0 | ns |

1. Internal Timing Parameters are not tested and are for reference only.

Table 2-0036B/1048E
2. Refer to Timing Model in this data sheet for further details.
3. The XOR adjacent path can only be used by hard macros.

Internal Timing Parameters ${ }^{1}$

| PARAMETER | \# | DESCRIPTION | -125 |  | -100 |  | -90 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. |  |
| Outputs |  |  |  |  |  |  |  |  |  |
| tob | 49 | Output Buffer Delay | - | 1.3 | - | 2.0 | - | 1.7 | ns |
| tsl | 50 | Output Slew Limited Delay Adder | - | 10.0 | - | 10.0 | - | 12.0 | ns |
| toen | 51 | I/O Cell OE to Output Enabled | - | 4.3 | - | 5.1 | - | 6.4 | ns |
| todis | 52 | I/O Cell OE to Output Disabled | - | 4.3 | - | 5.1 | - | 6.4 | ns |
| tgoe | 53 | Global OE | - | 2.7 | - | 3.9 | - | 2.6 | ns |
| Clocks |  |  |  |  |  |  |  |  |  |
| tgy0 | 54 | Clock Delay, Y0 to Global GLB Clock Line (Ref. clock) | 0.9 | 0.9 | 2.0 | 2.0 | 2.8 | 2.8 | ns |
| tgy $1 / 2$ | 55 | Clock Delay, Y1 or Y2 to Global GLB Clock Line | 0.9 | 0.9 | 2.0 | 2.0 | 2.8 | 2.8 | ns |
| tgcp | 56 | Clock Delay, Clock GLB to Global GLB Clock Line | 0.8 | 1.8 | 0.8 | 1.8 | 0.8 | 1.8 | ns |
| tioy2/3 | 57 | Clock Delay, Y2 or Y3 to I/O Cell Global Clock Line | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | 0.5 | ns |
| tiocp | 58 | Clock Delay, Clock GLB to I/O Cell Global Clock Line | 0.8 | 1.8 | 0.8 | 1.8 | 0.8 | 1.8 | ns |
| Global Reset |  |  |  |  |  |  |  |  |  |
| tgr | 59 | Global Reset to GLB and I/O Registers | - | 2.8 | - | 4.3 | - | 4.5 | ns |

1. Internal timing parameters are not tested and are for reference only.
2. Refer to Timing Model in this data sheet for further details.

## Internal Timing Parameters ${ }^{1}$

| PARAMETER | \# | DESCRIPTION | -70 |  | -50 |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN. | MAX. | MIN. | MAX. |  |
| Outputs |  |  |  |  |  |  |  |
| tob | 49 | Output Buffer Delay | - | 2.2 | - | 3.2 | ns |
| tsl | 50 | Output Slew Limited Delay Adder | - | 12.0 | - | 12.0 | ns |
| toen | 51 | I/O Cell OE to Output Enabled | - | 6.9 | - | 7.9 | ns |
| todis | 52 | I/O Cell OE to Output Disabled | - | 6.9 |  | 7.9 | ns |
| tgoe | 53 | Global OE | - | 5.1 | - | 8.1 | ns |
| Clocks |  |  |  |  |  |  |  |
| tgy0 | 54 | Clock Delay, Y0 to Global GLB Clock Line (Ref. clock) | 2.8 | 2.8 | 3.3 | 3.3 | ns |
| tgy 1/2 | 55 | Clock Delay, Y1 or Y2 to Global GLB Clock Line | 2.8 | 2.8 | 3.3 | 3.3 | ns |
| tgcp | 56 | Clock Delay, Clock GLB to Global GLB Clock Line | 0.8 | 1.8 | 0.8 | 1.8 | ns |
| tioy2/3 | 57 | Clock Delay, Y2 or Y3 to I/O Cell Global Clock Line | 0.1 | 0.6 | 0.0 | 0.7 | ns |
| tiocp | 58 | Clock Delay, Clock GLB to I/O Cell Global Clock Line | 0.8 | 1.8 | 0.8 | 1.8 | ns |
| Global Reset |  |  |  |  |  |  |  |
| tgr | 59 | Global Reset to GLB and I/O Registers | - | 4.5 | - | 7.5 | ns |
| 1. Internal timing parameters are not tested and are for reference only. <br> 2. Refer to Timing Model in this data sheet for further details. |  |  |  |  |  |  |  |

ispLSI 1048E Timing Model


## Derivations of tsu, th and tco from the Product Term Clock ${ }^{1}$

```
tsu \(\quad=\) Logic + Reg su - Clock (min)
    \(=(\) tiobp \(+\boldsymbol{t g r p} 4+\mathbf{t} 20 \mathrm{ptxor})+(\mathbf{t g s u})-(\) tiobp \(+\boldsymbol{t g r p} 4+\mathbf{t p t c k}(\min ))\)
    \(=(\# 22+\# 30+\# 37)+(\# 40)-(\# 22+\# 30+\# 46)\)
    \(2.2 \mathrm{~ns}=(0.3+2.0+5.0)+(0.1)-(0.3+2.0+2.9)\)
th \(\quad=\) Clock (max) + Reg h - Logic
    \(=(\) tiobp \(+\boldsymbol{t g r p} 4+\) tptck \((\) max \())+(\) tgh \()-(\) tiobp \(+\boldsymbol{t g r p} 4+\) t20ptxor \()\)
    \(=(\# 22+\# 30+\# 46)+(\# 41)-(\# 22+\# 30+\# 37)\)
    \(3.5 \mathrm{~ns}=(0.3+2.0+4.0)+(4.5)-(0.3+2.0+5.0)\)
tco \(=\) Clock (max) + Reg co + Output
    \(=(\) tiobp \(+\boldsymbol{t g r p} 4+\) tptck \((\) max \())+(\) tgco \()+(\) torp \(+\mathbf{t o b})\)
    \(=(\# 22+\# 30+\# 46)+(\# 42)+(\# 47+\# 49)\)
    \(10.9 \mathrm{~ns}=(0.3+2.0+4.0)+(2.3)+(1.0+1.3)\)
```


## Derivations of tsu, th and tco from the Clock GLB 1

tsu $\quad=$ Logic + Reg su - Clock (min)
$=($ tiobp $+\mathbf{t g r p} 4+\mathbf{t} 20 \mathrm{ptxor})+(\mathbf{t g s u})-(\mathbf{t g y 0}(\min )+\mathbf{t g c o}+\mathbf{t g c p}(\min ))$
$=(\# 22+\# 30+\# 37)+(\# 40)-(\# 54+\# 42+\# 56)$
$3.4 \mathrm{~ns}=(0.3+2.0+5.0)+(0.1)-(0.9+2.3+0.8)$
th $\quad=$ Clock (max) + Reg h - Logic
$=(\boldsymbol{t g y} 0(\max )+\mathbf{t g c o}+\boldsymbol{t g c p}(\max ))+(\boldsymbol{t g h})-($ tiobp $+\boldsymbol{t g r p} 4+\mathbf{t} 20 \mathrm{ptxor})$
$=(\# 54+\# 42+\# 56)+(\# 41)-(\# 22+\# 30+\# 37)$
$2.2 \mathrm{~ns}=(0.9+2.3+1.8)+(4.5)-(0.3+2.0+5.0)$
tco $=$ Clock (max) + Reg co + Output
$=(\mathbf{t g y} 0(\max )+\mathbf{t g c o}+\mathbf{t g c p}(\max ))+(\mathbf{t g c o})+(\mathbf{t o r p}+\mathbf{t o b})$
$=(\# 54+\# 42+\# 56)+(\# 42)+(\# 47+\# 49)$
$9.6 \mathrm{~ns}=(0.9+2.3+1.8)+(2.3)+(1.0+1.3)$

1. Calculations are based upon timing specifications for the ispLSI 1048E-125.

## Maximum GRP Delay vs. GLB Loads



## Power Consumption

Power consumption in the ispLSI 1048E device depends on two primary factors: the speed at which the device is operating and the number of Product Terms used.

Figure 3 shows the relationship between power and operating speed.

Figure 3. Typical Device Power Consumption vs fmax


Notes: Configuration of twelve 16-bit counters, Typical current at $5 \mathrm{~V}, 25^{\circ} \mathrm{C}$

ICC can be estimated for the ispLSI 1048E using the following equation:
ICC $=20+(\#$ of PTs * 0.42) + (\# of nets * Max. freq * 0.010)
Where:
\# of PTs = Number of Product Terms used in design
\# of nets = Number of Signals used in device
Max. freq = Highest Clock Frequency to the device
The ICC estimate is based on typical conditions ( $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$, room temperature) and an assumption of 4 GLB loads on average exists. These values are for estimates only. Since the value of ICC is sensitive to operating conditions and the program in the device, the actual ICC should be verified.

## Pin Description

| NAME | PQFP / TQFP PIN NUMBERS |  |  |  |  |  | DESCRIPTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| I/O 0 - I/O 5 <br> I/O 6 - I/O 11 <br> I/O 12 - I/O 17 <br> I/O 18 - I/O 23 <br> I/O 24 - I/O 29 <br> I/O 30 - I/O 35 <br> I/O 36 - I/O 41 <br> I/O 42 - I/O 47 <br> I/O 48 - I/O 53 <br> I/O 54 - I/O 59 <br> I/O 60 - I/O 65 <br> I/O 66 - I/O 71 <br> I/O 72 - I/O 77 <br> I/O 78 - I/O 83 <br> I/O 84 - I/O 89 <br> I/O 90 - I/O 95 | $\begin{aligned} & 21, \\ & 27, \\ & 34, \\ & 40, \\ & 52, \\ & 58, \\ & 66, \\ & 72, \\ & 85, \\ & 91, \\ & 98, \\ & 104, \\ & 117, \\ & 123, \\ & 2, \\ & 8, \end{aligned}$ | 22, <br> 28, <br> 35, <br> 41, <br> 53, <br> 59, <br> 67, <br> 73, <br> 86, <br> 92, <br> 99, <br> 105, <br> 118, <br> 124, <br> 3, <br> 9 , | 23, <br> 29, <br> 36, <br> 42, <br> 54, <br> 60, <br> 68, <br> 74, <br> 87, <br> 93, <br> 100, <br> 106, <br> 119, <br> 125, <br> 4 , <br> 10, | 24, <br> 30, <br> 37, <br> 43, <br> 55, <br> 61, <br> 69, <br> 75, <br> 88, <br> 94, <br> 101, <br> 107, <br> 120, <br> 126, <br> 5, <br> 11, | 25, <br> 31, <br> 38, <br> 44, <br> 56, <br> 62, <br> 70, <br> 76, <br> 89, <br> 95, <br> 102, <br> 108, <br> 121, <br> 127, <br> 6 , <br> 12, | 26, <br> 32, <br> 39, <br> 45, <br> 57, <br> 63, <br> 71, <br> 77, <br> 90, <br> 96, <br> 103, <br> 109, <br> 122, <br> 128, <br> 7, <br> 13 | Input/Output Pins - These are the general purpose I/O pins used by the logic array. |
| GOE0, GOE1 | 64, | 114 |  |  |  |  | Global Output Enable input pins. |
| IN 2, IN 4 IN 6 - IN 11 | $\begin{aligned} & 47, \\ & 84, \end{aligned}$ | $\begin{aligned} & 51 \\ & 110, \end{aligned}$ | 111, | 115, | 116, | 14 | Dedicated input pins to the device. |
| $\overline{\text { ispEN }}$ $\text { SDI/IN } 0^{1}$ | 18 20 |  |  |  |  |  | Input - Dedicated in-system programming enable input pin. This pin is brought low to enable the programming mode. When low, the MODE, SDI, SDO and SCLK controls become active. <br> Input - This pin performs two functions. When ispEN is logic low, it functions as an input pin to load programming data into the device. SDI/IN 0 also is used as one of the two control pins for the ISP state machine. When ispEN is high, it functions as a dedicated input pin. |
| MODE/IN $1^{1}$ | 46 |  |  |  |  |  | Input - This pin performs two functions. When $\overline{\text { ispEN }}$ is logic low, it functions as pin to control the operation of the isp state machine. When ispEN is high, it functions as a dedicated input pin. |
| $\text { SDO/IN } 3^{1}$ | 50 |  |  |  |  |  | Output/Input - This pin performs two functions. When ispEN is logic low, it functions as an output pin to read serial shift register data. When ispEN is high, it functions as a dedicated input pin. |
| SCLK/IN $5^{1}$ | 78 |  |  |  |  |  | Input - This pin performs two functions. When $\overline{\text { ispEN }}$ is logic low, it functions as a clock pin for the Serial Shift Register. When ispEN is high, it functions as a dedicated input pin. |
| RESET |  |  |  |  |  |  | Active Low (0) Reset pin which resets all of the GLB and I/O registers in the device. |
| YO | 15 |  |  |  |  |  | Dedicated Clock input. This clock input is connected to one of the clock inputs of all of the GLBs on the device. |
| Y1 |  |  |  |  |  |  | Dedicated Clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any GLB on the device. |
| Y2 | 80 |  |  |  |  |  | Dedicated Clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any GLB and/or any I/O cell on the device. |
| Y3 | 79 |  |  |  |  |  | Dedicated Clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any I/O cell on the device. |
| GND | $\begin{aligned} & 1, \\ & 97 \end{aligned}$ | $\begin{aligned} & 17, \\ & 112 \end{aligned}$ | $33,$ |  |  |  | Ground (GND) |
| VCC |  | 48, |  |  |  |  |  |

1. Pins have dual function capability.

Table 2-0002C-48E

## Pin Configuration

## ispLSI 1048E 128-Pin PQFP Pinout Diagram



1. Pins have dual function capability.

## Pin Configuration

ispLSI 1048E 128-Pin TQFP Pinout Diagram


1. Pins have dual function capability.

## Package Thermal Characteristics

For the ispLSI 1048E-125LT, it is strongly recommended that the actual Icc be verified to ensure that the maximum junction temperature ( $T_{J}$ ) with power supplied is not exceeded. Depending on the specific logic design and clock speed, airflow may be required to satisfy the maxi-
mum allowable junction temperature $\left(T_{J}\right)$ specification. Please refer to the Thermal Management section of the Lattice Semiconductor Data Book or CD-ROM for additional information on calculating $T_{J}$.

Part Number Description


## ispLSI 1048E Ordering Information

## Conventional Packaging

COMMERCIAL

| FAMILY | fmax (MHz) | tpd (ns) | ORDERING NUMBER | PACKAGE |
| :---: | :---: | :---: | :---: | :---: |
| ispLSI | 125 | 7.5 | ispLSI 1048E-125LQ | 128-Pin PQFP |
|  | 125 | 7.5 | ispLSI 1048E-125LT | 128-Pin TQFP |
|  | 100 | 10 | ispLSI 1048E-100LQ | 128-Pin PQFP |
|  | 100 | 10 | ispLSI 1048E-100LT | 128-Pin TQFP |
|  | 90 | 10 | ispLSI 1048E-90LQ | 128-Pin PQFP |
|  | 90 | 10 | ispLSI 1048E-90LT | 128-Pin TQFP |
|  | 70 | 15 | ispLSI 1048E-70LQ | 128-Pin PQFP |
|  | 70 | 15 | ispLSI 1048E-70LT | 128-Pin TQFP |
|  | 50 | 20 | ispLSI 1048E-50LQ | 128-Pin PQFP |
|  |  | 20 | ispLSI 1048E-50LT | 128-Pin TQFP |

INDUSTRIAL

| FAMILY | fmax $(\mathrm{MHz})$ | tpd $(\mathrm{ns})$ | ORDERING NUMBER | PACKAGE |
| :---: | :---: | :---: | :---: | :---: |
| ispLSI | 70 | 15 | ispLSI 1048E-70LQI* | $128-$ Pin PQFP |
|  | 50 | 20 | ispLSI 1048E-50LQI* | $128-P i n ~ P Q F P ~$ |

[^0]
## ispLSI 1048E Ordering Information (Cont.)

## Lead-Free Packaging

COMMERCIAL

| FAMILY | fmax (MHz) | tpd (ns) | ORDERING NUMBER | PACKAGE |
| :---: | :---: | :---: | :---: | :---: |
| ispLSI | 125 | 7.5 | ispLSI 1048E-125LQN | Lead-Free 128-Pin PQFP |
|  | 125 | 7.5 | ispLSI 1048E-125LTN | Lead-Free 128-Pin TQFP |
|  | 100 | 10 | ispLSI 1048E-100LQN | Lead-Free 128-Pin PQFP |
|  | 100 | 10 | ispLSI 1048E-100LTN | Lead-Free 128-Pin TQFP |
|  | 90 | 10 | ispLSI 1048E-90LQN | Lead-Free 128-Pin PQFP |
|  | 90 | 10 | ispLSI 1048E-90LTN | Lead-Free 128-Pin TQFP |
|  | 70 | 15 | ispLSI 1048E-70LQN | Lead-Free 128-Pin PQFP |
|  | 70 | 15 | ispLSI 1048E-70LTN | Lead-Free 128-Pin TQFP |
|  | 50 | 20 | ispLSI 1048E-50LQN | Lead-Free 128-Pin PQFP |
|  | 50 | 20 | ispLSI 1048E-50LTN | Lead-Free 128-Pin TQFP |

INDUSTRIAL

| FAMILY | $\operatorname{fmax}(\mathrm{MHz})$ | tpd $(\mathrm{ns})$ | ORDERING NUMBER | PACKAGE |
| :---: | :---: | :---: | :---: | :---: |
| ispLSI | 70 | 15 | ispLSI 1048E-70LQNI | Lead-Free 128-Pin PQFP |

## Revision History

| Date | Version |  |
| :---: | :---: | :--- |
| - | 11 | Change Summary |
| August 2006 | 12 | Previous Lattice release. |

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[^0]:    *Use 1048E-70 for new 1048E-50 designs.

